

Product Specification

XBLW SN74LS74

Dual D-type flip-flop with set and reset;
positive-edge trigger

WEB | www.xinboleic.com



Description

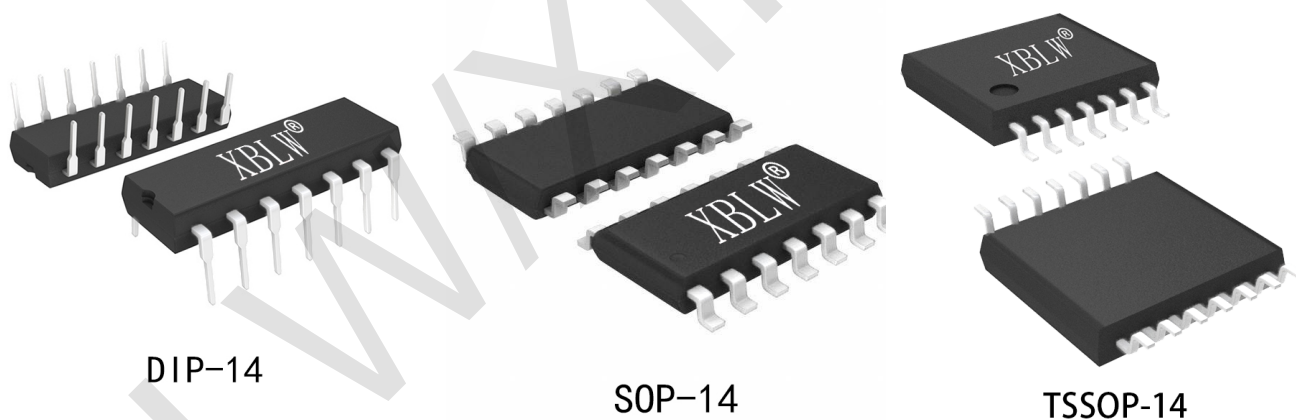
The SN74LS74 is a dual positive edge triggered D-type flip-flop. They have individual data (nD), clock (nCP), set ($n\bar{SD}$) and reset ($n\bar{RD}$) inputs, and complementary nQ and $n\bar{Q}$ outputs. Data at the nD -input, that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition, is stored in the flip-flop and appears at the nQ output. Schmitt-trigger action in the clock input, makes the circuit highly tolerant to slower clock rise and fall times. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

Features

- Buffered inputs
- Wide operating voltage range: 2 V to 6 V
- Symmetrical output impedance
- Low power dissipation
- Balanced propagation delays
- Specified from -20°C to $+85^{\circ}\text{C}$
- Packaging information: DIP-14/SOP-14/TSSOP-14

Applications

- Convert a momentary switch to a toggle switch
- Divide a clock signal by 2 or 4



Ordering Information

| Product Model | Package Type | Marking | Packing | Packing Qty |
|-------------------|--------------|---------|---------|--------------|
| XBLW SN74LS74N | DIP-14 | 74LS74N | Tube | 1000Pcs/Box |
| XBLW SN74LS74DTR | SOP-14 | 74LS74 | Tape | 2500Pcs/Reel |
| XBLW SN74LS74TDTR | TSSOP-14 | 74LS74 | Tape | 3000Pcs/Reel |

Block Diagram

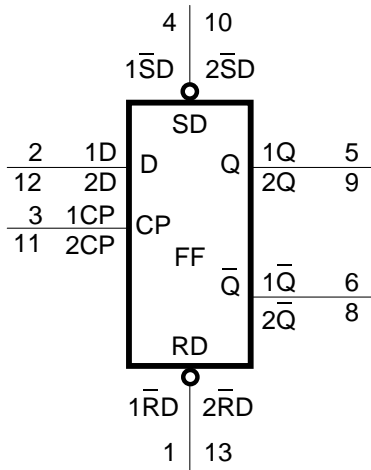


Figure 1. Logic symbol

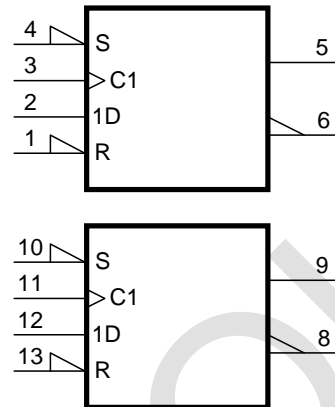


Figure 2. IEC logic symbol

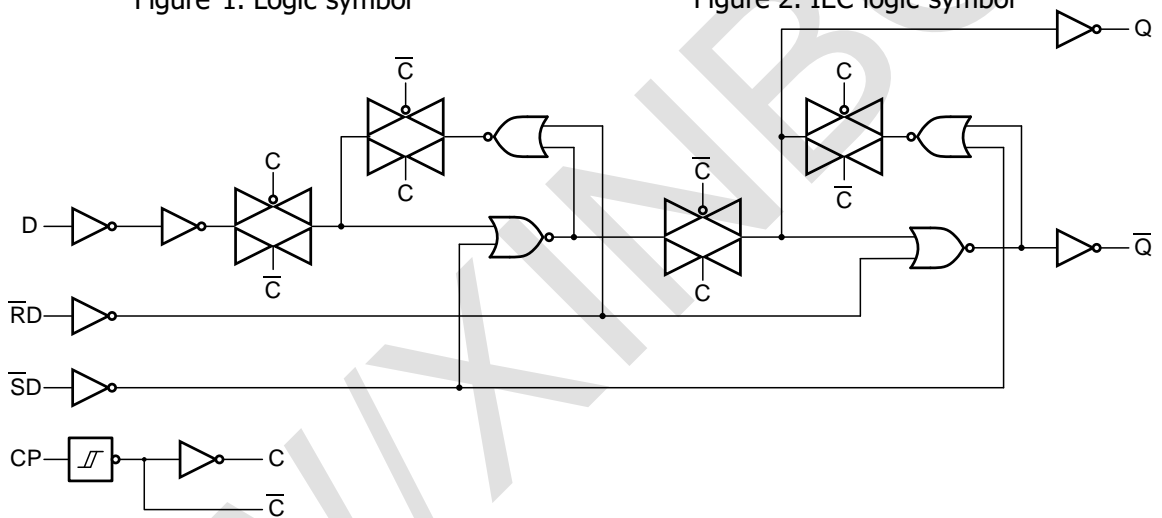


Figure 3. Logic diagram for one flip-flop

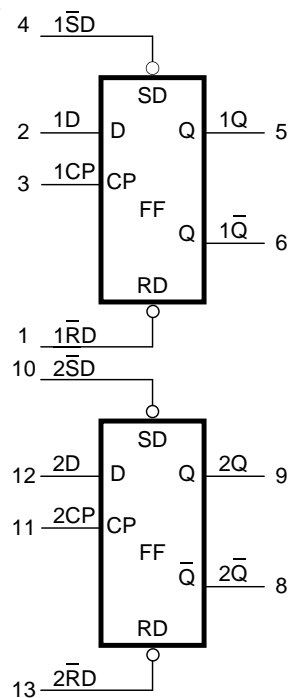
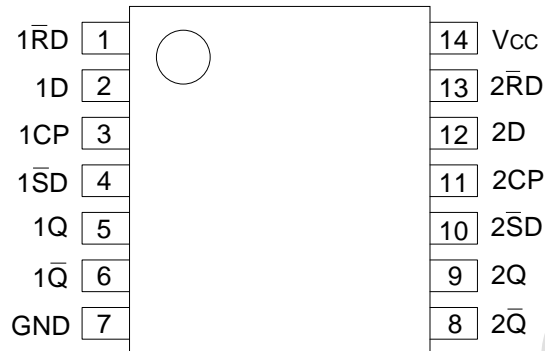


Figure 4. Functional diagram

Pin Configurations



Pin Description

| Pin No. | Pin Name | Description |
|---------|------------------|--|
| 1 | $\overline{1RD}$ | asynchronous reset-direct input (active LOW) |
| 2 | 1D | data input |
| 3 | 1CP | clock input (LOW-to-HIGH, edge-triggered) |
| 4 | $\overline{1SD}$ | asynchronous set-direct input (active LOW) |
| 5 | 1Q | output |
| 6 | $\overline{1Q}$ | complement output |
| 7 | GND | ground (0V) |
| 8 | $\overline{2Q}$ | complement output |
| 9 | 2Q | output |
| 10 | $\overline{2SD}$ | asynchronous set-direct input (active LOW) |
| 11 | 2CP | clock input (LOW-to-HIGH, edge-triggered) |
| 12 | 2D | data input |
| 13 | $\overline{2RD}$ | asynchronous reset-direct input (active LOW) |
| 14 | V _{cc} | supply voltage |

Function Table

| Input | | | | Output | |
|------------------|------------------|-----|----|--------|-----------------|
| \overline{nSD} | \overline{nRD} | nCP | nD | nQ | \overline{nQ} |
| L | H | X | X | H | L |
| H | L | X | X | L | H |
| L | L | X | X | H | H |

| Input | | | | Output | |
|------------------|------------------|-----|----|-------------------|-----------------------|
| \overline{nSD} | \overline{nRD} | nCP | nD | nQ _{n+1} | \overline{nQ}_{n+1} |
| H | H | ↑ | L | L | H |
| H | H | ↑ | H | H | L |

Note: H=HIGH voltage level; L=LOW voltage level; X=don't care;

↑=LOW-to-HIGH transition; Q_{n+1}=state after the next LOW-to-HIGH CP transition.

Electrical Parameter

Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

| Parameter | Symbol | Conditions | Min. | Max. | Unit |
|-------------------------|-----------|--------------------------------------|-----------|----------|------|
| supply voltage | V_{CC} | - | -0.5 | +7 | V |
| input clamping current | I_{IK} | $V_I < -0.5V$ or $V_I > V_{CC}+0.5V$ | - | ± 20 | mA |
| output clamping current | I_{OK} | $V_O < -0.5V$ or $V_O > V_{CC}+0.5V$ | - | ± 20 | mA |
| output current | I_O | $-0.5V < V_O < V_{CC}+0.5V$ | - | ± 25 | mA |
| supply current | I_{CC} | - | - | 100 | mA |
| ground current | I_{GND} | - | -100 | - | mA |
| total power dissipation | P_{tot} | - | - | 500 | mW |
| storage temperature | T_{stg} | - | -65 | +150 | °C |
| soldering temperature | T_L | 10s | DIP | 245 | °C |
| | | | SOP/TSSOP | 260 | |

Recommended Operating Conditions

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|---------------------|---------------|------|------|----------|------|
| supply voltage | V_{CC} | - | 2.0 | 5.0 | 6.0 | V |
| input voltage | V_I | - | 0 | - | V_{CC} | V |
| output voltage | V_O | - | 0 | - | V_{CC} | V |
| input transition rise and fall rate | $\Delta t/\Delta V$ | $V_{CC}=2.0V$ | - | - | 625 | ns/V |
| | | $V_{CC}=4.5V$ | - | 1.67 | 139 | ns/V |
| | | $V_{CC}=6.0V$ | - | - | 83 | ns/V |
| ambient temperature | T_{amb} | - | -20 | - | +85 | °C |

Electrical Characteristics

DC Characteristics

($T_{amb}=-20^{\circ}C$ to $+85^{\circ}C$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit | |
|---------------------------|----------|---|------------------------------|------|-----------|------|---|
| HIGH-level input voltage | V_{IH} | $V_{CC}=2.0V$ | 1.5 | 1.2 | - | V | |
| | | $V_{CC}=4.5V$ | 3.15 | 2.4 | - | V | |
| | | $V_{CC}=6.0V$ | 4.2 | 3.2 | - | V | |
| LOW-level input voltage | V_{IL} | $V_{CC}=2.0V$ | - | 0.8 | 0.5 | V | |
| | | $V_{CC}=4.5V$ | - | 2.1 | 1.35 | V | |
| | | $V_{CC}=6.0V$ | - | 2.8 | 1.8 | V | |
| HIGH-level output voltage | V_{OH} | $V_I=V_{IH}$ or V_{IL} | $I_O=-4.0mA$; $V_{CC}=4.5V$ | 3.84 | 4.32 | - | V |
| | | | $I_O=-5.2mA$; $V_{CC}=6.0V$ | 5.34 | 5.81 | - | V |
| LOW-level output voltage | V_{OL} | $V_I=V_{IH}$ or V_{IL} | $I_O=4.0mA$; $V_{CC}=4.5V$ | - | 0.15 | 0.33 | V |
| | | | $I_O=5.2mA$; $V_{CC}=6.0V$ | - | 0.16 | 0.33 | V |
| input leakage current | I_I | $V_I=V_{CC}$ or GND; $V_{CC}=6.0V$ | - | - | ± 1.0 | uA | |
| supply current | I_{CC} | $V_I=V_{CC}$ or GND; $I_O=0A$; $V_{CC}=6.0V$ | - | - | 40 | uA | |
| input capacitance | C_I | - | - | 3.5 | - | pF | |

AC Characteristics

 ($T_{amb} = -20^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit | |
|---------------------------------|-----------|---|---------------------------------------|------|------|------|-----|
| nCP to nQ, nQ propagation delay | t_{pd} | see Figure 6 ^[1] | $V_{CC}=2.0\text{V}$ | - | 47 | 220 | ns |
| | | | $V_{CC}=4.5\text{V}$ | - | 17 | 44 | ns |
| | | | $V_{CC}=5.0\text{V}; C_L=15\text{pF}$ | - | 14 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | - | 14 | 37 | ns |
| nSD to nQ, nQ propagation delay | t_{pd} | see Figure 7 ^[1] | $V_{CC}=2.0\text{V}$ | - | 50 | 250 | ns |
| | | | $V_{CC}=4.5\text{V}$ | - | 18 | 50 | ns |
| | | | $V_{CC}=5.0\text{V}; C_L=15\text{pF}$ | - | 15 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | - | 14 | 43 | ns |
| nRD to nQ, nQ propagation delay | t_{pd} | see Figure 7 ^[1] | $V_{CC}=2.0\text{V}$ | - | 52 | 250 | ns |
| | | | $V_{CC}=4.5\text{V}$ | - | 19 | 50 | ns |
| | | | $V_{CC}=5.0\text{V}; C_L=15\text{pF}$ | - | 16 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | - | 15 | 43 | ns |
| nQ, nQ transition time | t_t | see Figure 6 ^[2] | $V_{CC}=2.0\text{V}$ | - | 19 | 95 | ns |
| | | | $V_{CC}=4.5\text{V}$ | - | 7 | 19 | ns |
| | | | $V_{CC}=6.0\text{V}$ | - | 6 | 16 | ns |
| CP pulse width | t_w | see Figure 6 | $V_{CC}=2.0\text{V}$ | 100 | 19 | - | ns |
| | | | $V_{CC}=4.5\text{V}$ | 20 | 7 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | 17 | 6 | - | ns |
| nSD, nRD pulse width | t_w | see Figure 7 | $V_{CC}=2.0\text{V}$ | 100 | 19 | - | ns |
| | | | $V_{CC}=4.5\text{V}$ | 20 | 7 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | 17 | 6 | - | ns |
| nSD, nRD recovery time | t_{rec} | see Figure 7 | $V_{CC}=2.0\text{V}$ | 40 | 3 | - | ns |
| | | | $V_{CC}=4.5\text{V}$ | 8 | 1 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | 7 | 1 | - | ns |
| nD to nCP set-up time | t_{su} | see Figure 6 | $V_{CC}=2.0\text{V}$ | 75 | 6 | - | ns |
| | | | $V_{CC}=4.5\text{V}$ | 15 | 2 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | 13 | 2 | - | ns |
| nD to nCP hold time | t_h | see Figure 6 | $V_{CC}=2.0\text{V}$ | 3 | -6 | - | ns |
| | | | $V_{CC}=4.5\text{V}$ | 3 | -2 | - | ns |
| | | | $V_{CC}=6.0\text{V}$ | 3 | -2 | - | ns |
| nCP maximum frequency | f_{max} | see Figure 6 | $V_{CC}=2.0\text{V}$ | 4.8 | 23 | - | MHz |
| | | | $V_{CC}=4.5\text{V}$ | 24 | 69 | - | MHz |
| | | | $V_{CC}=5.0\text{V}; C_L=15\text{pF}$ | - | 76 | - | MHz |
| | | | $V_{CC}=6.0\text{V}$ | 28 | 82 | - | MHz |
| power dissipation capacitance | C_{PD} | $C_L=50\text{pF}; f=1\text{ MHz}; V_I = \text{GND to } V_{CC}$ ^[3] | - | 24 | - | pF | |

Note:

 [1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 [2] t_t is the same as t_{THL} and t_{TLH} .

 [3] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$$P_D = (C_{PD} \times V_{CC}^2 \times f_i \times N) + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where: f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF; V_{CC} = supply voltage in V;

 N = number of inputs switching; $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

Testing Circuit

AC Testing Circuit

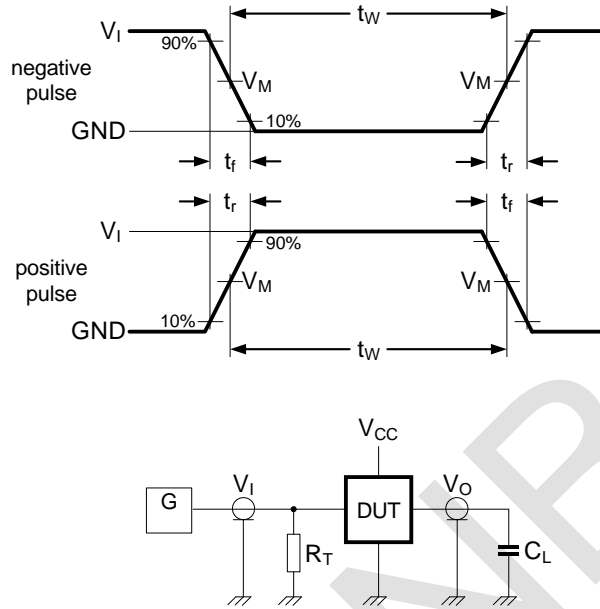


Figure 5. Test circuit for measuring switching times

Definitions for test circuit:

C_L =load capacitance including jig and probe capacitance.

R_T =termination resistance should be equal to the output impedance Z_o of the pulse generator.

AC Testing Waveforms

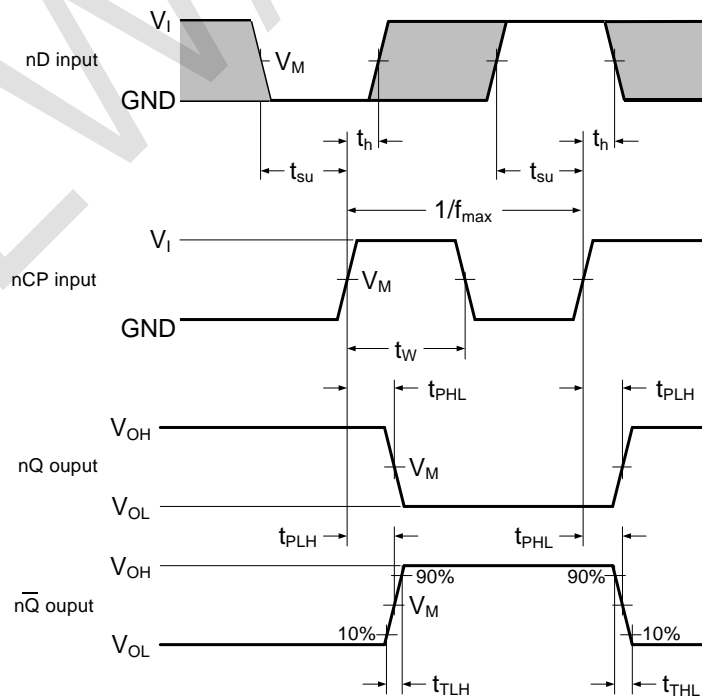


Figure 6. Input to output propagation delays

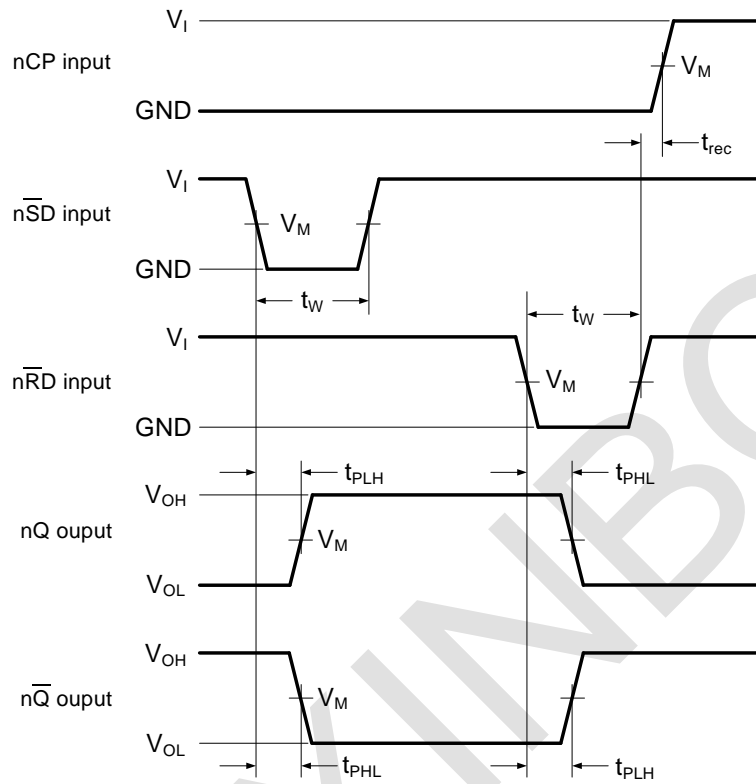


Figure 7. Set and reset propagation delays, pulse widths and recovery time

Measurement Points

| Type | Input | Output |
|----------|---------------------|---------------------|
| | V_M | V_M |
| SN74LS74 | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |

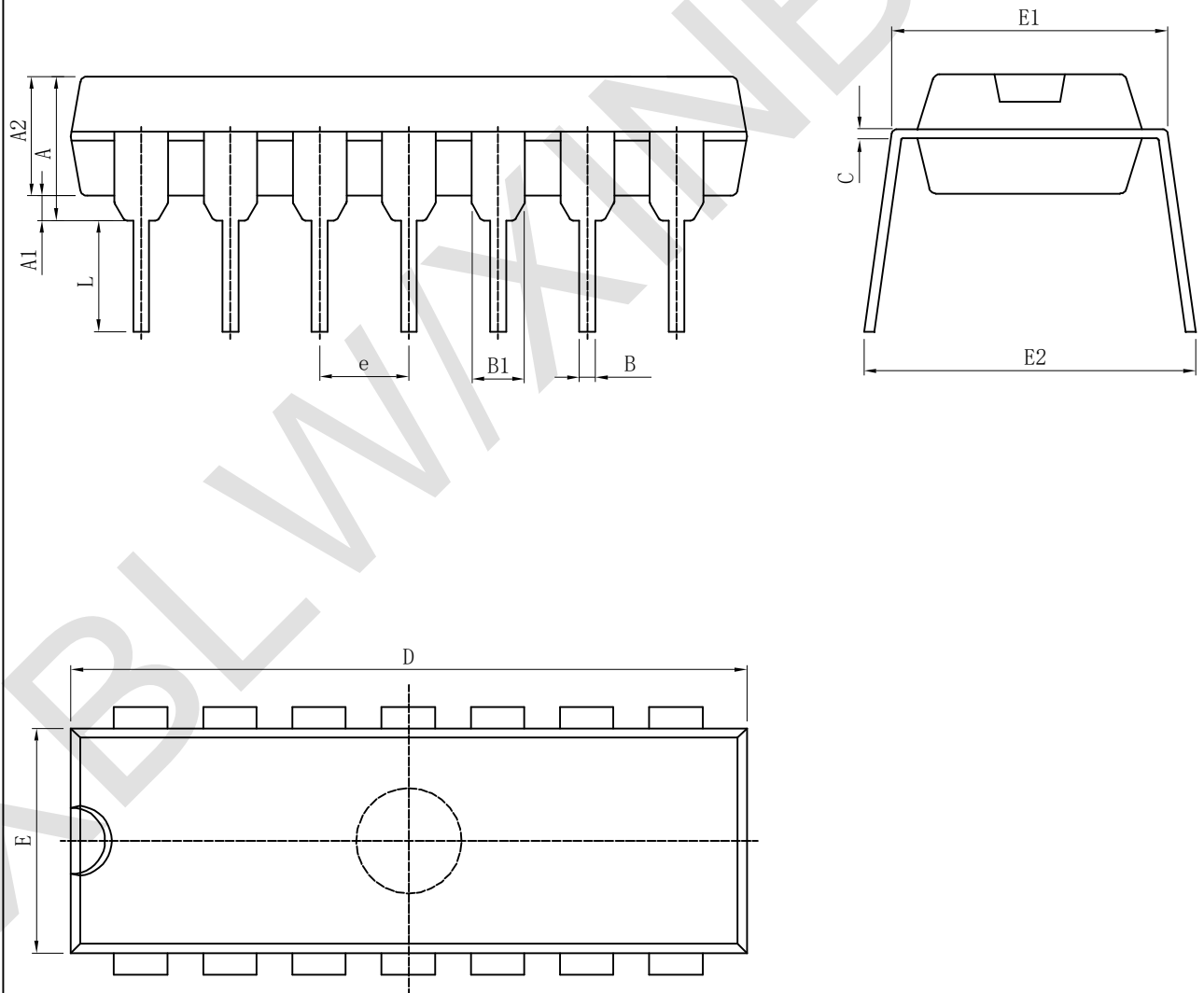
Test Data

| Type | Input | | Load | | Test |
|----------|----------|------------|------------|-------|--------------------|
| | V_I | t_r, t_f | C_L | R_L | |
| SN74LS74 | V_{CC} | 6.0ns | 15pF, 50pF | 1kΩ | t_{PLH}, t_{PHL} |

Package Information

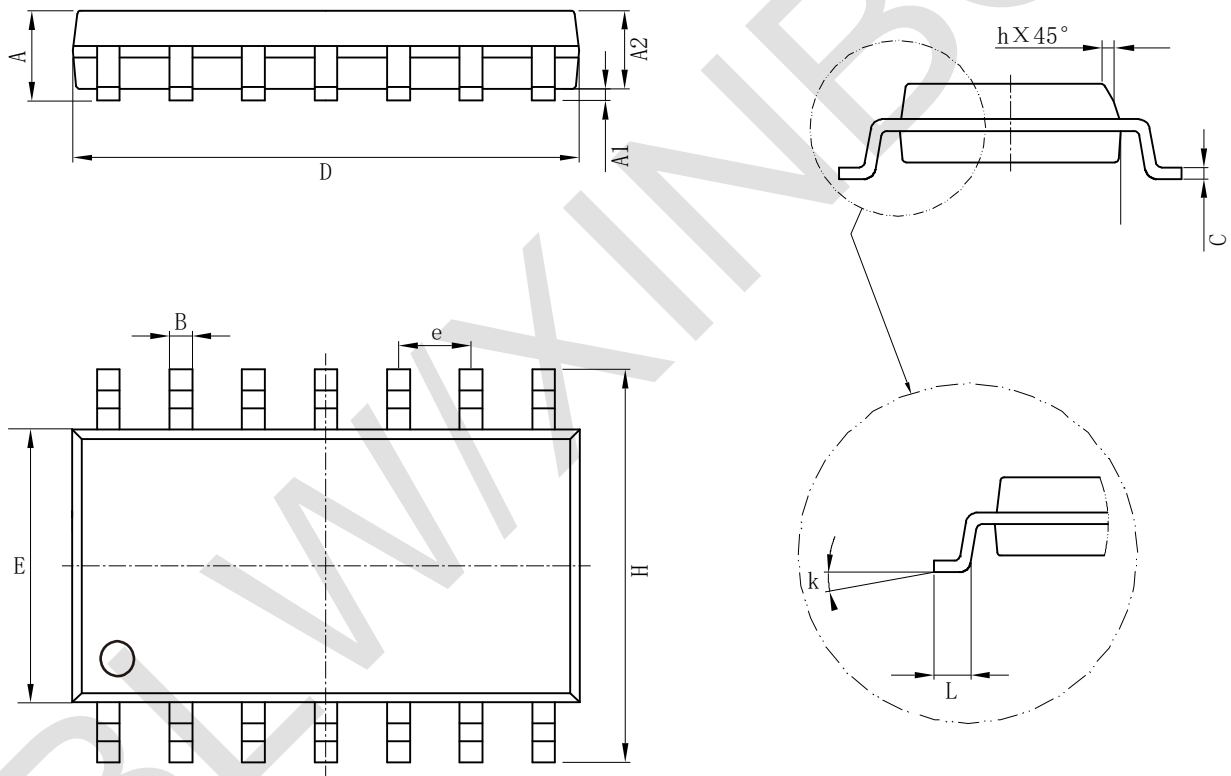
· DIP-14

| Size Symbol | Dimensions In Millimeters | | Size Symbol | Dimensions In Inches | |
|----------------|---------------------------|----------|----------------|----------------------|----------|
| | Min (mm) | Max (mm) | | Min (in) | Max (in) |
| A | 3.710 | 4.310 | A | 0.146 | 0.170 |
| A1 | 0.510 | | A1 | 0.020 | |
| A2 | 3.200 | 3.600 | A2 | 0.126 | 0.142 |
| B | 0.380 | 0.570 | B | 0.015 | 0.022 |
| B1 | 1.524 (BSC) | | B1 | 0.060 (BSC) | |
| C | 0.204 | 0.360 | C | 0.008 | 0.014 |
| D | 18.800 | 19.200 | D | 0.740 | 0.756 |
| E | 6.200 | 6.600 | E | 0.244 | 0.260 |
| E1 | 7.320 | 7.920 | E1 | 0.288 | 0.312 |
| e | 2.540 (BSC) | | e | 0.100 (BSC) | |
| L | 3.000 | 3.600 | L | 0.118 | 0.142 |
| E2 | 8.400 | 9.000 | E2 | 0.331 | 0.354 |



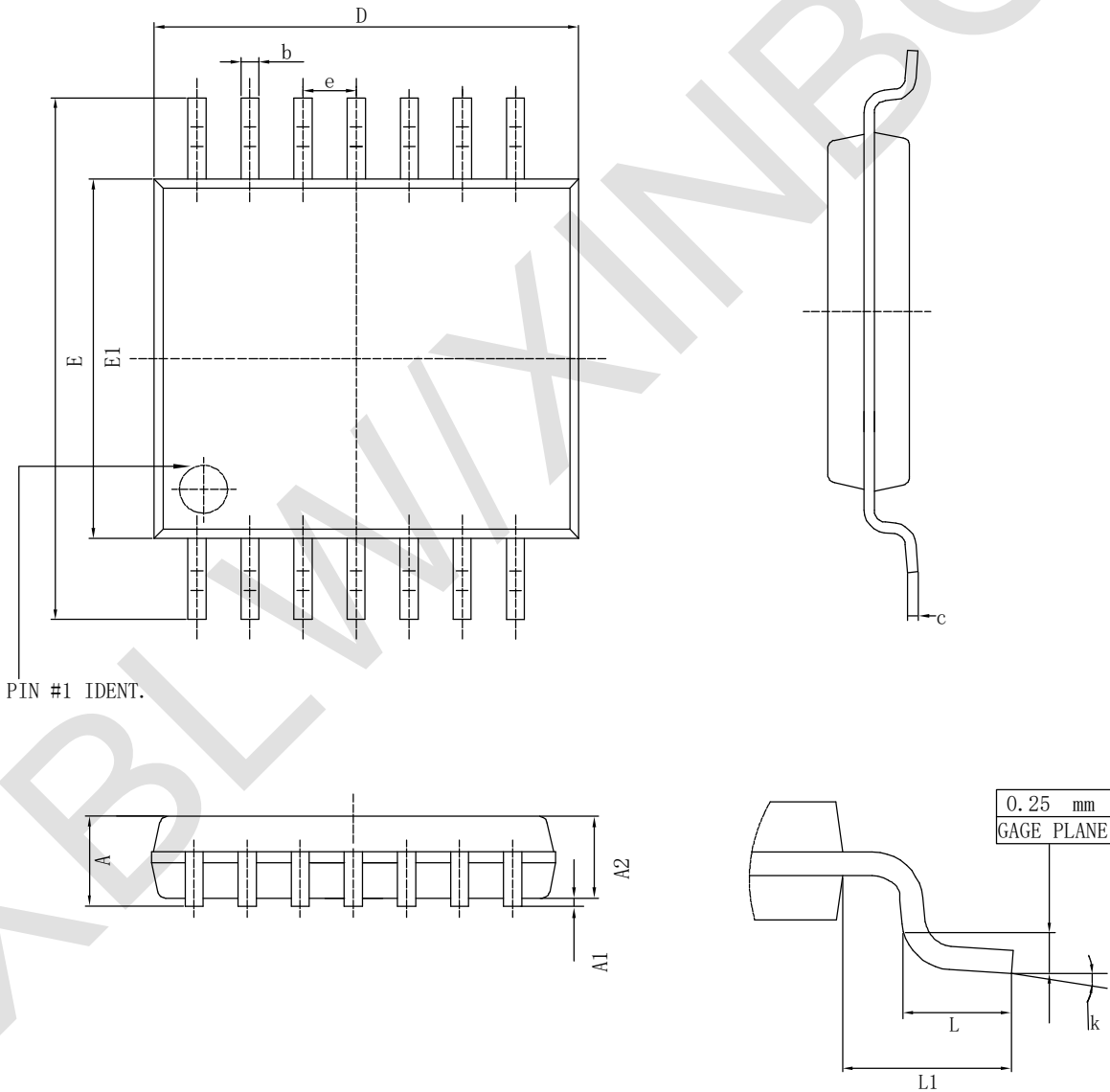
· SOP-14

| Size Symbol | Dimensions In Millimeters | | Size Symbol | Dimensions In Inches | |
|----------------|---------------------------|------------|----------------|----------------------|------------|
| | Min (mm) | Max (mm) | | Min (in) | Max (in) |
| A | 1.350 | 1.750 | A | 0.050 | 0.068 |
| A1 | 0.100 | 0.250 | A1 | 0.004 | 0.009 |
| A2 | 1.100 | 1.650 | A2 | 0.040 | 0.060 |
| B | 0.330 | 0.510 | B | 0.010 | 0.020 |
| C | 0.190 | 0.250 | C | 0.007 | 0.009 |
| D | 8.550 | 8.750 | D | 0.330 | 0.340 |
| E | 3.800 | 4.000 | E | 0.150 | 0.150 |
| e | 1.27 | | e | 0.05 | |
| H | 5.800 | 6.200 | H | 0.220 | 0.240 |
| h | 0.250 | 0.500 | h | 0.009 | 0.020 |
| L | 0.400 | 1.270 | L | 0.015 | 0.050 |
| k | 8° (max) | | k | 8° (max) | |



· TSSOP-14

| Size Symbol | Dimensions In Millimeters | | Size Symbol | Dimensions In Inches | |
|----------------|---------------------------|----------|----------------|----------------------|----------|
| | Min (mm) | Max (mm) | | Min (in) | Max (in) |
| A | | 1.200 | A | | 0.047 |
| A1 | 0.050 | 0.150 | A1 | 0.002 | 0.006 |
| A2 | 0.800 | 1.050 | A2 | 0.031 | 0.041 |
| b | 0.190 | 0.300 | b | 0.007 | 0.012 |
| c | 0.090 | 0.200 | c | 0.004 | 0.0089 |
| D | 4.900 | 5.100 | D | 0.193 | 0.201 |
| E | 6.200 | 6.600 | E | 0.244 | 0.260 |
| E1 | 4.300 | 4.500 | E1 | 0.169 | 0.176 |
| e | 0.65 | | e | 0.0256 | |
| L | 0.450 | 0.750 | L | 0.018 | 0.030 |
| L1 | 1.00 | | L1 | 0.039 | |
| k | 0° | 8° | k | 0° | 8° |



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